

Product Description

# **Product Specification**

# PE4134

# High Linearity Quad MOSFET Mixer for PCS & 3G BTS

#### Features

- Integrated, single-ended RF & LO interfaces
- High linearity: IIP3 >+31 dBm, 1.9 GHz (+17 dBm LO)
- Low-conversion loss: 7.4 dB (+17 dBm LO)
- High isolation: Typical LO-IF at 33 dB, LO-RF at 31 dB
- Optimized for low-side LO injection
- Packaged in a 6-lead 3x3 mm DFN

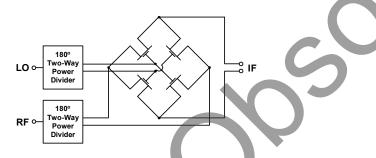
# Figure 1. Functional Diagram

CMOS.

up-conversion applications.

#### Figure 2. Package Type

6-lead 3x3 mm DFN



The PE4134 is a high linearity, passive Quad MOSFET Mixer

+20 dBm. This mixer integrates passive matching networks to

range performance over a broad LO drive range of up to

provide single-ended interfaces for the RF and LO ports,

eliminating the need for external RF baluns or matching

down-conversion using low-side LO injection for PCS & 3G

The PE4134 is manufactured on Peregrine's UltraCMOS<sup>™</sup> process, a patented variation of silicon-on-insulator (SOI)

technology on a sapphire substrate, offering the performance of GaAs with the economy and integration of conventional

networks. The PE4134 is optimized for frequency

Base Station applications, and is also suitable for

for PCS & 3G Base Station Receivers, exhibiting high dynamic

# Table 1. AC and DC Electrical Specifications @ +25 °C

Minimum Parameter Typical Maximum Units Frequency Range: LO 1540 1740 MHz ---RF 1800 2000 MHz IF<sup>1</sup> 260 MHz Conversion Loss<sup>2</sup> 7.4 8.0 dB Isolation: LO-RF 27 31 dB LO-IF dB 27 33 Input IP3 1.8 GHz 26 29 dBm 31 1.9 GHz 33 dBm 2.0 GHz 28 31 dBm Input 1 dB Compression 22 dBm

Notes: 1. An IF frequency of 260 MHz is a nominal frequency. The IF frequency can be specified by the user as long as the RF and LO frequencies are within the specified maximum and minimum.

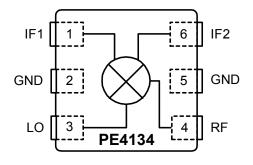
2. Conversion Loss includes loss of IF transformer (M/A COM ETK4-2T, nominal loss 0.7 dB at 260 MHz).

\*Test conditions unless otherwise noted: IF = 260 MHz, LO input drive = 17 dBm, RF input drive = 3 dBm.





# Figure 3. Pin Configuration (Top View)



#### Table 2. Pin Descriptions

Pin No.	Pin Name	Description		
1	IF1	IF differential output		
2	GND	Ground connections for Mixer. Traces should be physically short and connect immediately to ground plane for best performance. The exposed solder pad must also be soldered to the ground plane for best performance.		
3	LO	LO Input		
4	RF	RF Input		
5	GND	Ground connections for Mixer. Traces should be physically short and connect immediately to ground plane for best performance. The exposed solder pad must also be soldered to the ground plane for best performance.		
6	IF2	IF differential output		

Symbol	Parameter/Conditions	Min	Max	Units
Τ <sub>st</sub>	Storage temperature range	-65	150	°C
T <sub>OP</sub>	Operating temperature range	-40	85	°C
P <sub>LO</sub>	LO input power		20	dBm
P <sub>RF</sub>	RF input power		12	dBm
V <sub>ESD</sub>	ESD Sensitive Device		250	V

#### Table 3. Absolute Maximum Ratings

Absolute Maximum Ratings are those values listed in the above table. Exceeding these values may cause permanent device damage. Functional operation should be restricted to the limits in the DC Electrical Specifications table. Exposure to absolute maximum ratings for extended periods may affect device reliability.

# Electrostatic Discharge (ESD) Precautions

When handling this UltraCMOS<sup>™</sup> device, observe the same precautions that you would use with other ESD-sensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the rating specified.

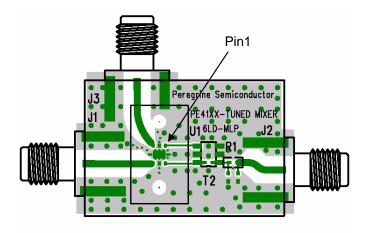
#### Latch-Up Avoidance

Unlike conventional CMOS devices, UltraCMOS<sup>™</sup> devices are immune to latch-up.



# Evaluation Kit

Figure 4. Evaluation Board Layout



#### Figure 5. Evaluation Board Schematic Diagram

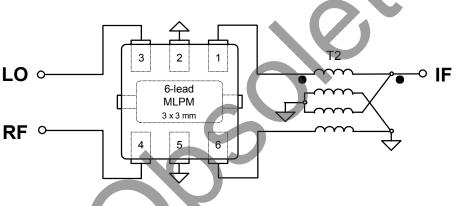
#### Table 4. Bill of Materials

Reference	Value / Description		
T2	M/A Com ETK4-2T		
R1	0 Ω		
U1	PE4134 MLP Mixer		
J1, J2, J3	SMA Connector		

#### **Applications Support**

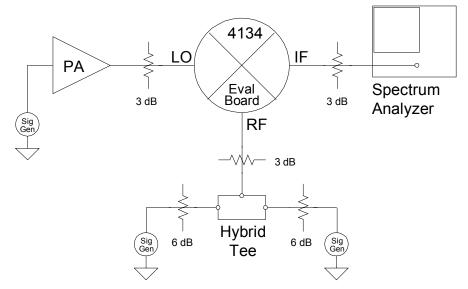
If you have a problem with your evaluation kit or if you have applications questions, please contact applications support:

E-Mail: help@psemi.com (fastest response) Phone: (858) 731-9400



T2, M/A-Com E-Series RF 4:1 Transformer, 2.0 - 1000 MHz, ETK4-2T

# Figure 6. Evaluation Board Testing Block Diagram, 2-Tone Setup

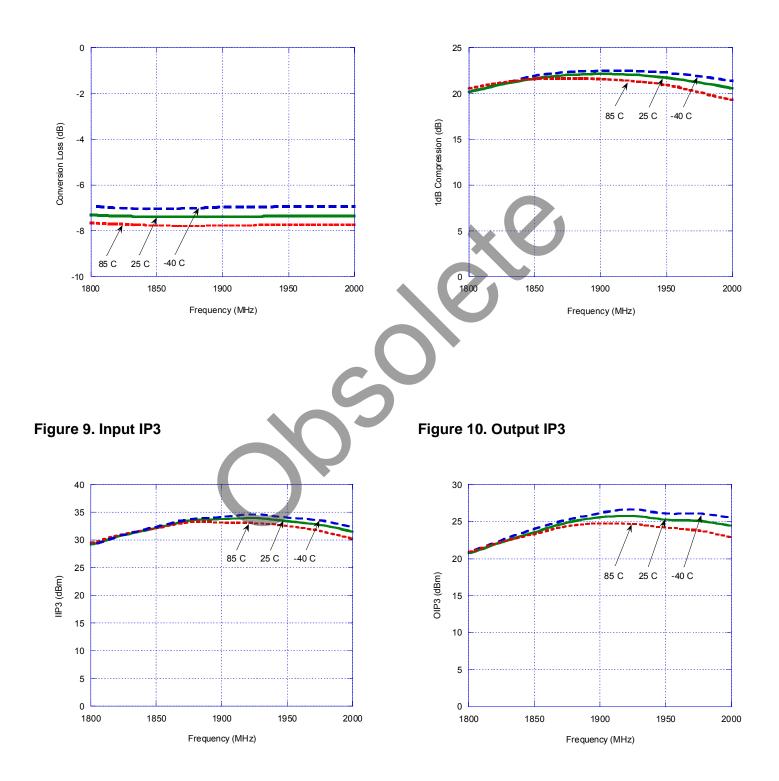




# Typical Performance Data (LO=17 dBm, RF=3 dBm, IF=260 MHz)

# Figure 7. Conversion Loss

Figure 8. Input 1dB Compression

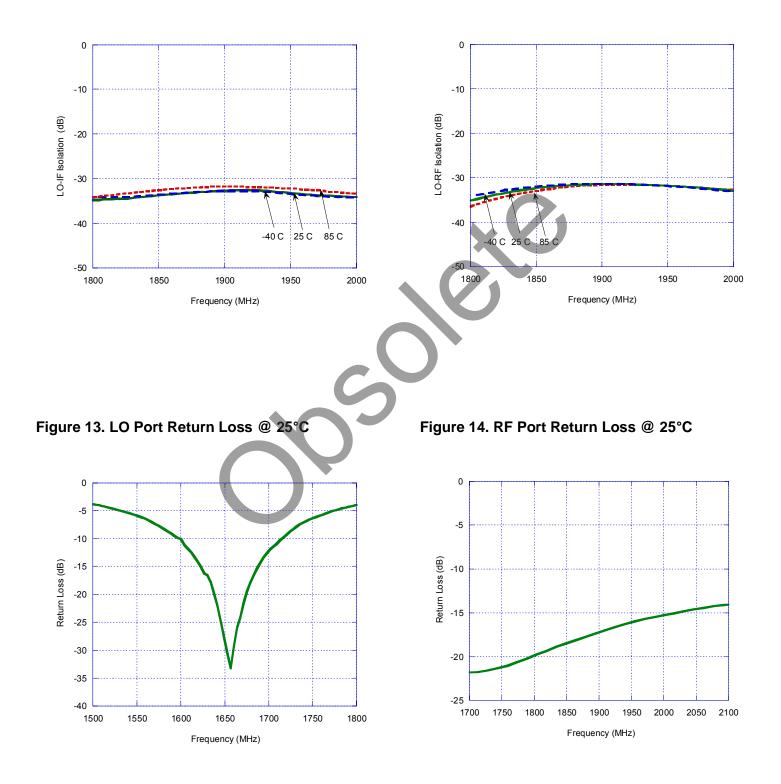




# Typical Performance Data (LO=17 dBm, RF=3 dBm, IF=260 MHz)

# Figure 11. LO-IF Isolation vs. Frequency

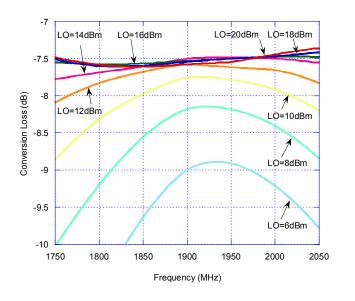
Figure 12. LO-RF Isolation vs. Frequency

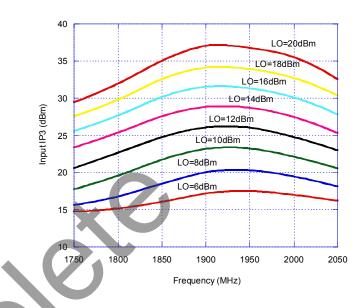




#### Typical Performance Data @ +25 °C (RF=3 dBm, IF=260 MHz)

# Figure 15. Conversion Loss across LO Power





#### Figure 16. Input IP3 across LO Power

# Table 6. Spurious Response

Spurious Response						
	mRF+nLO					
	nLO					
mRF	1	2	3	4		
1	0	32	22	43		
2	57	49	61	62		
3	64	71	64	65		
4	>85	>85	>85	81		

Normalized to dB below PIF

(RF=1900 Mhz @ 3 dBm, LO=1640 MHz @ 17 dBm)

#### Table 5. Spurious Response

Spurious Response					
		mRF+nLO			
	nLO				
mRF	1	2	3	4	
1	5	37	30	50	
2	49	55	65	59	
3	75	>85	78	80	
4	>85	84	>85	>85	

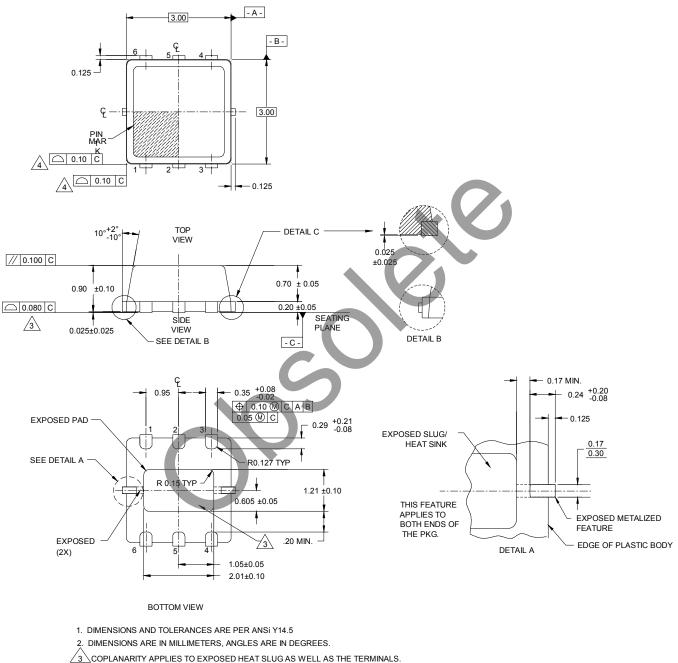
Normalized to dB below PIF

(RF=1900 Mhz @ 3 dBm, LO=1640 MHz @ 17 dBm)



# Figure 17. Package Drawing

6-lead DFN



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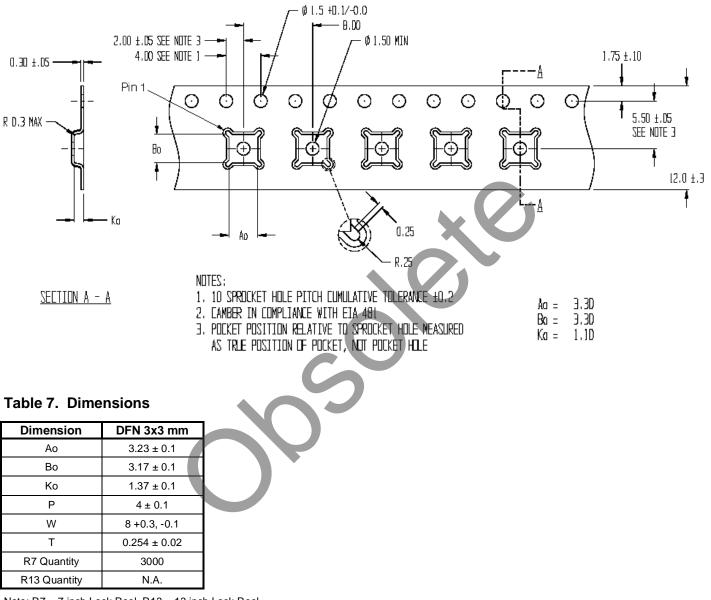
4 PROFILE TOLERANCE APPLIES TO PLASTIC BODY ONLY.





#### Figure 18. Tape and Reel Specifications

6-lead DFN



Note: R7 = 7 inch Lock Reel, R13 = 13 inch Lock Reel

#### Table 8. Ordering Information

Order Code	Part Marking	Description	Package	Shipping Method
4134-01	4134	PE4134-06DFN3x3-12800F	6-lead 3x3 mm DFN	12800 units / Canister
4134-02	4134	PE4134-06DFN3x3-3000C	6-lead 3x3 mm DFN	3000 units / T&R
4134-00	4134-EK	PE4134-06DFN3x3-EK	Evaluation Board	1 / Box

# Sales Offices

#### The Americas

#### **Peregrine Semiconductor Corporation**

9450 Carroll Park Drive San Diego, CA 92121 Tel 858-731-9400 Fax 858-731-9499

#### Europe

#### Peregrine Semiconductor Europe

Bâtiment Maine 13-15 rue des Quatre Vents F- 92380 Garches, France Tel: +33-1-47-41-91-73 Fax : +33-1-47-41-91-73

#### Space and Defense Products

#### Americas:

Tel: 505-881-0438 Fax: 505-881-0443

#### Europe, Asia Pacific:

180 Rue Jean de Guiramand 13852 Aix-En-Provence cedex 3, France Tel: +33(0) 4 4239 3361 Fax: +33(0) 4 4239 7227

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# Data Sheet Identification

# Advance Information

The product is in a formative or design stage. The data sheet contains design target specifications for product development. Specifications and features may change in any manner without notice.

# Preliminary Specification

The data sheet contains preliminary data. Additional data may be added at a later date. Peregrine reserves the right to change specifications at any time without notice in order to supply the best possible product.

# **Product Specification**

The data sheet contains final data. In the event Peregrine decides to change the specifications, Peregrine will notify customers of the intended changes by issuing a DCN (Document Change Notice).

#### North Asia Pacific

#### Peregrine Semiconductor K.K.

5A-5, 5F Imperial Tower 1-1-1 Uchisaiwaicho, Chiyoda-ku Tokyo 100-0011 Japan Tel: +81-3-3502-5211 Fax: +81-3-3502-5213

#### Peregrine Semiconductor, Korea

#B-2402, Kolon Tripolis, #210 Geumgok-dong, Bundang-gu, Seongnam-si Gyeonggi-do, 463-480 S. Korea Tel: +82-31-728-4300 Fax: +82-31-728-4305

# South Asia Pacific

**Peregrine Semiconductor, China** Shanghai, 200040, P.R. China Tel: +86-21-5836-8276 Fax: +86-21-5836-7652

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